

INTERCONNECTS

SERIES 335, 364, 435, 464 • .100" GRID (.018" DIA. PINS), LOW PROFILE • SINGLE AND DOUBLE ROW STRIPS

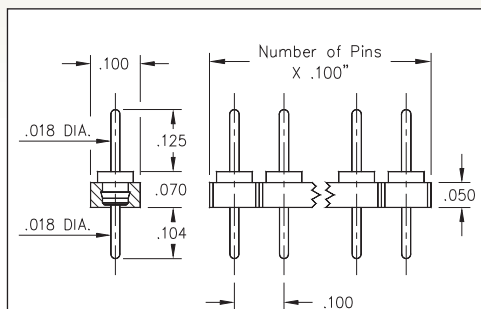


FIG. 1

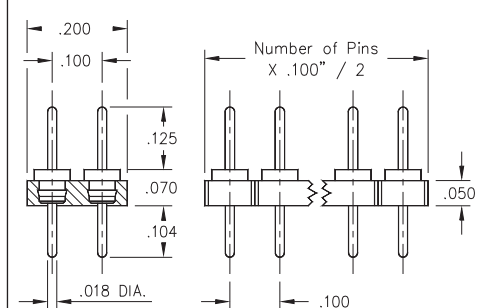


FIG. 2

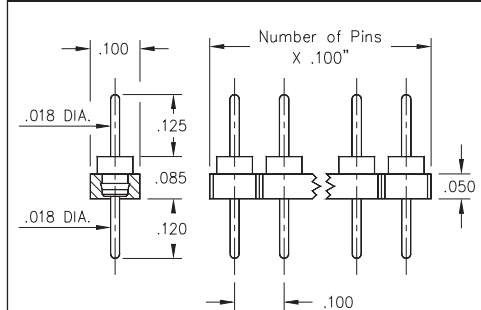


FIG. 3

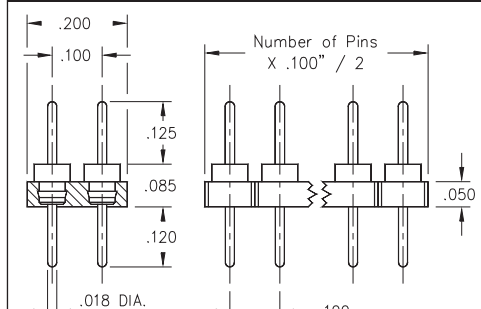


FIG. 4

- Series 335 and 435 single and double row PCB interconnects offer a .070" profile, the lowest available
- Series 364 and 464 single and double row PCB interconnects offer .085" profile above board
- Series 335 and 435 use MM #3516 pins. See page 212 for details
- Series 364 and 464 use MM #6458 pins. See page 213 for details
- Insulators are high temperature thermoplastic, suitable for all soldering operations



ORDERING INFORMATION

FIG. 1	Series 335...160	Single Row .070" Profile Pin Header										
	335-XX-1--00-160000 Specify number of pins 01-32											
FIG. 2	Series 435...160	Double Row .070" Profile Pin Header										
	435-XX-2--00-160000 Specify number of pins 04-72											
FIG. 3	Series 364...580	Single Row .085" Profile Pin Header										
	364-10-1--00-580000 Specify number of pins 01-32											
FIG. 4	Series 464...580	Double Row .085" Profile Pin Header										
	464-10-2--00-580000 Specify number of pins 04-72											
RoHS - 2 2011/65/EU XX=Plating Code See Below For Electrical, Mechanical & Environmental Data, See page 264 <table><tr><td>SPECIFY PLATING CODE XX=</td><td>10 </td><td>90</td><td>40 </td><td></td></tr><tr><td>Pin Plating </td><td>10 μ" Au</td><td>200 μ" Sn/Pb</td><td>200 μ" Sn</td><td></td></tr></table>			SPECIFY PLATING CODE XX=	10 	90	40 		Pin Plating 	10 μ" Au	200 μ" Sn/Pb	200 μ" Sn	
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